



General Description

The MAX8814 intelligent, stand-alone constant-current, constant-voltage (CCCV), thermally regulated linear charger is designed for charging a single-cell lithiumion (Li+) battery. The MAX8814 integrates the currentsense circuit, MOSFET pass element, thermalregulation circuitry, and eliminates the reverse-blocking Schottky diode to create the simplest and smallest charging solution for handheld equipment.

The IC controls the charging sequence from the prequalification state through constant-current fast-charge and the final constant voltage charge. Proprietary thermal-regulation circuitry limits the die temperature during fast-charging or when the IC is exposed to high ambient temperatures, allowing maximum charging current without damaging the IC.

The MAX8814 achieves high flexibility by providing an adjustable fast-charge current through an external resistor. Other features include an active-low control input (EN) and an active-low input power-source detection output (POK). The IC also features a booting assistant circuit that distinguishes input sources and battery connection and provides an output signal (ABO) for system booting.

The MAX8814 accepts an input supply range from 4.25V to 28V, but disables charging if the input voltage exceeds +7V to protect against unqualified or faulty AC adapters. The IC operates over the extended temperature range (-40°C to +85°C) and is available in a compact 8-pin thermally enhanced TDFN 2mm x 2mm package (0.8mm max height).

Applications

Cellular and Cordless Phones Smartphones and PDAs

MP3 Players

Digital Still Cameras

USB Appliances

Charging Cradles and Docks

Bluetooth® Equipment

Bluetooth is a registered trademark of Bluetooth SIG.

Pin Configuration appears at end of data sheet.

Features

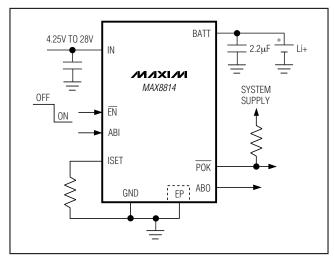
- ♦ CCCV, Thermally Regulated Linear 1-Cell Li+ **Battery Charger**
- ♦ No External MOSFET, Reverse Blocking Diode, or **Current-Sense Resistor**
- ♦ Programmable Fast-Charge Current (1ARMS max)
- **♦ Proprietary Die Temperature Regulation Control** (+115°C)
- ♦ 4.25V to 28V Input Voltage Range with Input OVP Above +7V
- ♦ Charge-Current Monitor for Fuel Gauging (ISET)
- ◆ Low Dropout Voltage (300mV at 500mA)
- ♦ Input Power-Source Detection Output (POK), Charge-Enable Input (EN)
- **♦** Soft-Start Limits Inrush Current
- ♦ Output for Autobooting (ABO)
- ♦ Tiny 2mm x 2mm, 8-Pin TDFN Package, 0.8mm Height (max)

Ordering Information

PART	TEMP	PIN-	PKG	TOP
	RANGE	PACKAGE	CODE	MARK
MAX8814ETA+	-40°C to +85°C	8 TDFN 2mm x 2mm	T822+2	ABI

⁺Denotes a lead-free and RoHS-compliant package.

Typical Operating Circuit



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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

IN to GND	0.3V to +30V
ABI, BATT, EN, POK to GND	0.3V to +6V
ABO to GND	$0.3V \text{ to } (V_{BATT} + 0.3V)$
ISET to GND	0.3V to +4V
IN to BATT Continuous Current	1A _{RMS}
Continuous Power Dissipation ($T_A = +70^{\circ}$	°C)
8-Pin TDFN (derate 11.9mW/°C above	+70°C)
(Itil DOD)	000 5144

BATT Short-Circuit Duration	Continuous
Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN}=5V, V_{BATT}=4V, R_{\overline{POK}}=1M\Omega$ to BATT, $\overline{EN}=0V, R_{ISET}=2.8k\Omega$ to GND, $C_{BATT}=2.2\mu F, T_A=-40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A=+25^{\circ}C$.) (Note 1)

PARAMETER	CONDITIONS			TYP	MAX	UNITS	
Input Voltage Range			0		28	V	
Input Operating Voltage Range					6.50	V	
Power-OK Threshold	V _{IN} - V _{BATT} ,	V _{IN} rising		40		mV	
Tower-OK Threshold	10mV hysteresis (typ)	V _{IN} falling		30		IIIV	
Overvoltage-Lockout Trip Threshold	V _{IN} rising, 100mV hysteres	sis (typ)	6.5	7	7.5	V	
	Constant-current charging	mode (I _{BATT} = 0A)		0.8	1.35		
IN Input Current	IC disabled (VEN = 5V)			0.23	0.50	mA	
IN Input Current	$V_{IN} = 4V$,	$T_A = +25^{\circ}C$		0.021	0.065	IIIA	
	$V_{BATT} = 4.2V$	$T_A = +85^{\circ}C$		0.021			
BATT Input Current	V _{IN} = 0 to 4V, V _{BATT} = 4.2V			1	10	μΑ	
	IC disabled	IC disabled			3		
Battery Regulation Voltage	I OA	$T_A = 0$ °C to +85°C	4.179	4.200	4.221	V	
Battery negulation voltage	$T_{A} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$		4.158	4.200	4.242		
Minimum BATT Bypass Capacitance				2.2		μF	
	V _{BATT} = 3.5V	$T_A = 0$ °C to +85°C	524	570	616		
Foot Charge Current		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	485	570	656		
Fast-Charge Current	$V_{BATT} = 3.5V$,	$T_A = 0$ °C to +85°C	89	107	125	mA	
	$R_{ISET} = 14k\Omega$	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	80	107	134		
Prequalification Charge Current	Percentage of the fast-charge current, V _{BATT} = 2.2V, T _A = 0°C to +85°C		4	10	15	%	
Die Temperature Regulation Threshold				+115		°C	
V _{BATT} Prequalification Threshold Voltage	V _{BATT} rising, 100mV hysteresis (typ)		2.3	2.5	2.7	V	
Current-Sense Amplifier Gain (IBATT to IISET)	I _{BATT} = 570mA			877.2		μΑ/Α	

2 ______ *M*/X///

ELECTRICAL CHARACTERISTICS (continued)

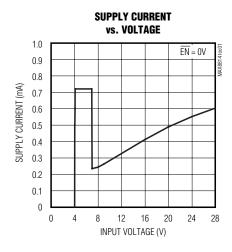
 $(V_{IN}=5V, V_{BATT}=4V, R_{\overline{POK}}=1M\Omega$ to BATT, $\overline{EN}=0V, R_{ISET}=2.8k\Omega$ to GND, $C_{BATT}=2.2\mu F, T_A=-40^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A=+25^{\circ}C.)$ (Note 1)

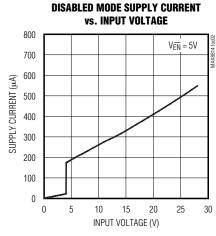
PARAMETER	CO	MIN	TYP	MAX	UNITS	
Regulator Dropout Voltage (VIN - VBATT)	V _{BATT} = 4.1V, I _{BATT} = 425mA			240	500	mV
EN Logic-Input Low Voltage	4.25V < V _{IN} < 6.5V				0.4	V
EN Logic-Input High Voltage	4.25V < V _{IN} < 6.5V		1.3			V
EN and ABI Internal Pulldown Resistance		100	200	400	kΩ	
ABI Logic-Input Low Voltage	$V_{IN} = 0V$	V _{IN} = 0V			0.4	V
ABI Logic-Input High Voltage	$V_{IN} = 0V$	1.3			V	
ABO Output Low Voltage	I _{ABO (SINK)} = 1mA	I _{ABO} (SINK) = 1mA			0.4	V
ABO Output High Voltage	IABO (SOURCE) = 1mA		V _{BATT} - 0.4V			V
POK Output Low Voltage	I _{POK} = 5mA			0.4	V	
POK Output High Leakage	\overline{POK} Output High Leakage $V_{A} = +25^{\circ}C$			0.001	1	
Current	V _{POK} = 5.5V	T _A = +85°C		0.002		μΑ

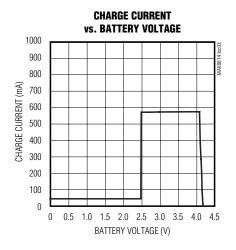
Note 1: Specifications are 100% production tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design and characterization.

Typical Operating Characteristics

 $(V_{IN}=5V,V_{BATT}=4V,R_{\overline{POK}}=1M\Omega$ to BATT, $\overline{EN}=0V,R_{ISET}=2.8k\Omega$ to GND, $C_{BATT}=2.2\mu F,T_{A}=-40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_{A}=+25^{\circ}C$.)



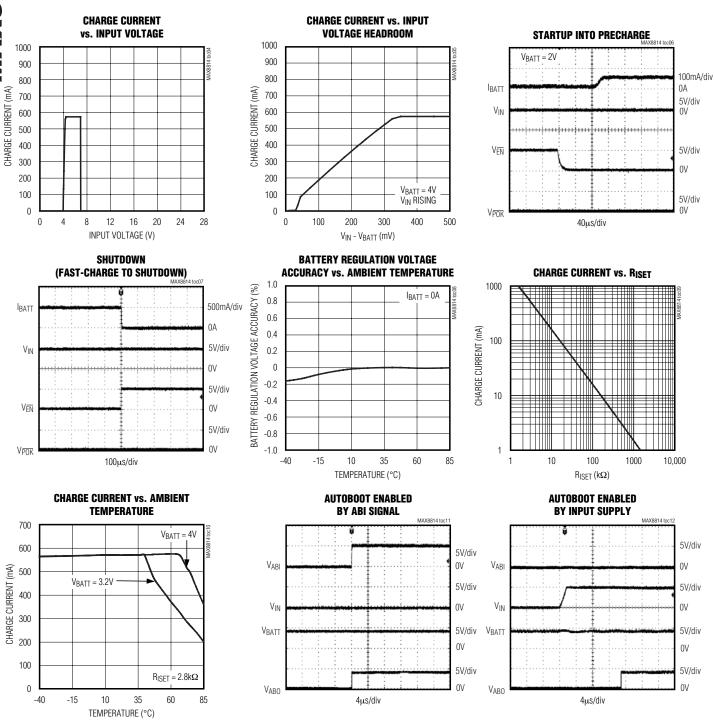




_Typical Operating Characteristics (continued)

M/XI/M

 $(V_{IN}=5V, V_{BATT}=4V, R_{\overline{POK}}=1M\Omega$ to BATT, $\overline{EN}=0V, R_{ISET}=2.8k\Omega$ to GND, $C_{BATT}=2.2\mu F, T_A=-40^{\circ}C$ to +85°C, unless otherwise noted. Typical values are at $T_A=+25^{\circ}C$.)



Pin Description

PIN	NAME	FUNCTION
1	IN	Input Supply Voltage. Bypass IN to GND with a 1µF or larger ceramic capacitor to minimize line noise and maximize input transient rejection.
2	GND	Ground. Connect GND and the exposed paddle to a large copper ground plane for maximum power dissipation. Connect GND to the exposed paddle directly under the IC.
3	ISET	Charge-Current Program and Fast-Charge Current Monitor. Output current from ISET is 877.2µA per ampere of battery charging current. Set the charging current by connecting a resistor (R2 in Figure 3) from ISET to GND. IFAST-CHARGE = 1596V / RISET. To configure the MAX8814 as a USB charger, see Figure 4.
4	ABI	Autobooting External Input. See the <i>Autobooting Assistant</i> section and Table 1 for autobooting conditions. ABI is pulled to GND through an internal 200k Ω resistor.
5	ABO	Autobooting Logic Output. See the <i>Autobooting Assistant</i> section and Table 1 for autobooting conditions.
6	ĒN	Logic-Level Enable Input. Drive $\overline{\text{EN}}$ high to disable charger. Drive $\overline{\text{EN}}$ low or leave unconnected for normal operation. $\overline{\text{EN}}$ has an internal 200k Ω pulldown resistor.
7	POK	Input-Voltage Status Indicator. Connect a $1M\Omega$ pullup resistor from \overline{POK} to an external system supply. \overline{POK} is an open-drain output that asserts low when $V_{IN} > 4.25V$ and $(V_{IN} - V_{BATT}) \ge 40mV$. If $V_{BATT} \ge (V_{IN} - 40mV)$, the IC is shut down and \overline{POK} becomes high impedance.
8	BATT	Battery Connection. Bypass BATT to GND with a minimum of 2.2µF of capacitor.
_	EP	Exposed Paddle. Connect the exposed paddle to a large ground plane for maximum power dissipation. Connect GND to the exposed paddle directly under the IC.

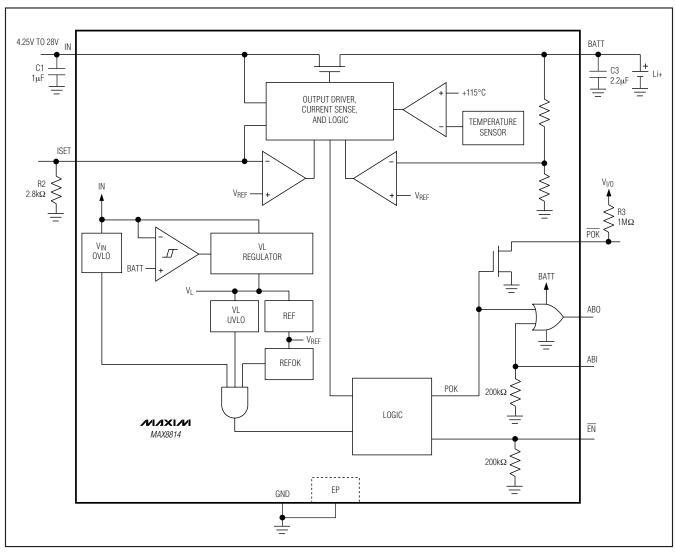


Figure 1. Functional Diagram

Detailed Description

The MAX8814 charger uses voltage, current, and thermal-control loops to charge a single Li+ cell and protect the battery (Figure 1). When a Li+ battery with a cell voltage below 2.5V is inserted, the MAX8814 charger enters the prequalification stage where it precharges that cell with 10% of the user-programmed fast-charge current (Figure 2). When the battery voltage exceeds 2.5V, the charger soft-starts as it enters the fast-charge stage. In the MAX8814, the fast-charge current level is programmed through a resistor from ISET to GND. As the battery voltage approaches 4.2V,

the charging current is reduced. Once the battery voltage reaches 4.2V, the IC then enters a constant voltage regulation mode to maintain the battery at full charge.

Thermal Regulation

The thermal-regulation loop limits the MAX8814 die temperature to +115°C by reducing the charge current as necessary. This feature not only protects the IC from overheating, but also allows a higher charge current without risking damage to the IC.

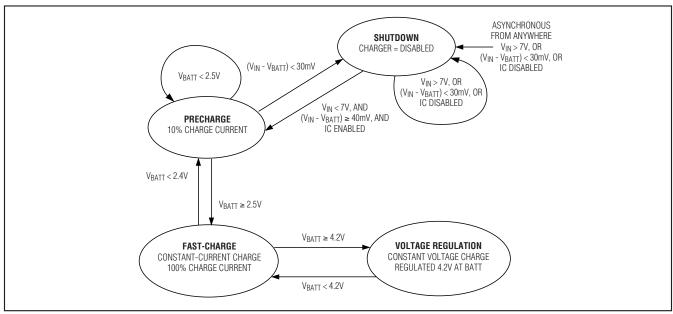


Figure 2. Charge-State Diagram

Charger Enable Input

The MAX8814 contains an active-low logic input (\overline{EN}) used to enable the charger. Drive \overline{EN} low, leave unconnected, or connect to GND to enable the charger-control circuitry. Drive \overline{EN} high to disable the charger-control circuitry. \overline{EN} has an internal 200k Ω pull-down resistor.

POK Output

The open-drain \overline{POK} output asserts low when $V_{IN} \ge 4.25V$ and $(V_{IN} - V_{BATT}) \ge 40 \text{mV}$ (typ, V_{IN} rising). \overline{POK} requires an external pullup resistor (1M Ω typ) to an external power supply. \overline{POK} is high impedance when $V_{BATT} \ge (V_{IN} - 40 \text{mV})$.

Autobooting Assistant

The MAX8814 contains an autobooting assistant circuit that generates an enable signal for system booting (ABO). The booting assistant functions as an internal "OR" gate (Figure 1). The first input is dependent on the input voltage (V_{IN}), and the second input is an external signal applied to ABI. The first input (POK) is driven high once $V_{IN} \ge 4.25V$ and ($V_{IN} - V_{BATT}$) $\ge 40mV$ (typ, V_{IN} rising).

The second input signal (ABI) is driven by an external source. ABI enables an autoboot signal (ABO high) when a battery is connected at BATT and is independent of \overline{POK} . If \overline{POK} is pulled low, the booting assistant always drives ABO high, regardless of ABI (see Table 1). ABI is pulled to GND through an internal 200k Ω resistor.

Table 1. ABO and POK States

ABI	BATT	POK	CHARGER STATE	ABO
Low	Present	Present Hi-Z Shutdown		Low
High	Present	Hi-Z	Shutdown	High
Х	Not present	ot present Low Fast-charge/voltage regulation		High
Х	Present	Low	Fast-charge/voltage regulation	High

X = Don't care.

If ABI is driven externally, a RC filter (R1 and C2 of Figure 3) is required for ESD protection and noise filtering. If ABI is supplied by a system's internal GPIO, or logic, the RC filter is not required.

Soft-Start

The soft-start algorithm activates when entering fast-charge mode. In the MAX8814, when the prequalification state is complete ($V_{BATT} \ge 2.5V$), the charging current ramps up in 250µs to the full charging current. This reduces the inrush current on the input supply.

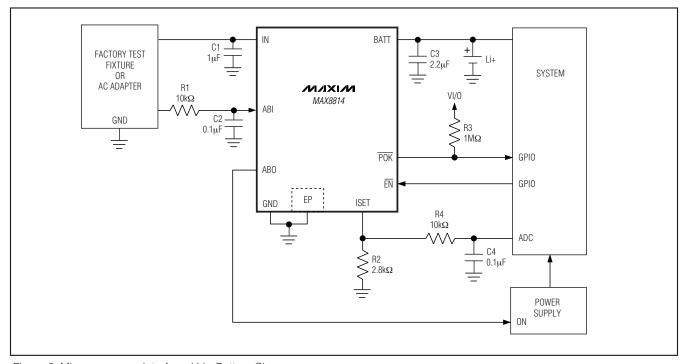


Figure 3. Microprocessor-Interfaced Li+ Battery Charger

Applications Information

Charge-Current Selection

The maximum charging current is programmed by an external resistor connected from ISET to GND (RISET). Calculate RISET as follows:

$$R_{ISET} = \frac{1596V}{I_{FAST-CHARGE}}$$

where IFAST-CHARGE is in amperes and RISET is in ohms. ISET can be used to monitor the fast-charge current level. The output current from ISET is 877.2μA per ampere of charging current. The output voltage at ISET is proportional to the charging current:

$$V_{ISET} = \frac{I_{CHARGE} \times R_{ISET}}{1140}$$

The voltage at ISET is nominally 1.4V at the selected fast-charge current and falls with charging current as the cell becomes fully charged or as the thermal-regulation circuitry activates.

Capacitor Selection

Connect a ceramic capacitor from BATT to GND for proper stability. Use a 2.2 μ F X5R ceramic capacitor for most applications. Connect a 1 μ F ceramic capacitor from IN to GND. Use a larger input bypass capacitor for high charging currents to reduce supply noise.

Thermal Considerations

The MAX8814 is available in a thermally enhanced TDFN package with an exposed paddle. Connect the exposed paddle to a large copper ground plane to provide a thermal contact between the device and the circuit board for increased power dissipation. The exposed paddle transfers heat away from the device, allowing the IC to charge the battery with maximum current, while minimizing the increase in die temperature.

DC Input Sources

The MAX8814 operates from a well-regulated DC source. The full charging input voltage range is 4.25V to 7V. The device can withstand up to 28V on the input without damage to the IC. If V_{IN} is greater than 7V, the internal overvoltage-protection circuitry disables charging until the input falls below 7V. An appropriate power supply must provide at least 4.25V at the desired peak charging current.

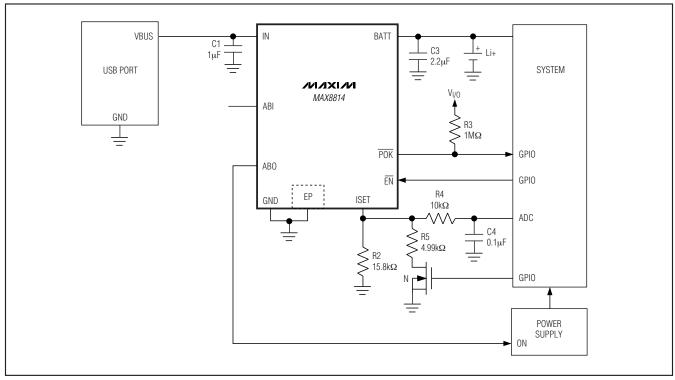


Figure 4. USB Battery Charger

Application Circuits

Microprocessor-Interfaced Charger

Figure 3 shows the MAX8814 as a microprocessor-cooperated Li+ battery charger. The MAX8814 begins charging the battery when $\overline{\text{EN}}$ is low. The microprocessor can drive $\overline{\text{EN}}$ high to disable the charger. The MAX8814 generates a $\overline{\text{POK}}$ signal to indicate the presence of an input supply. By monitoring VISET, the system can measure the charging current and decide when to terminate the charge.

USB-Powered Li-Ion Charger

The universal serial bus (USB) provides a high-speed serial communication port as well as power for the remote device. The MAX8814 can be configured to charge a battery at the highest current possible from the host port. Figure 4 shows the MAX8814 as a USB battery charger. To make the circuit compatible with either 100mA or 500mA USB ports, the circuit initializes at 100mA charging current. The microprocessor then enumerates the host to determine its current capability. If the host port is capable, the charging current is increased to 425mA to avoid exceeding the 500mA USB specification.

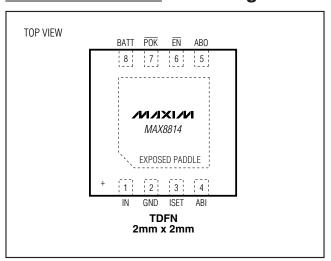
Layout and Bypassing

Place the input and output capacitors as close as possible to the IC. Provide a large copper ground plane to allow the exposed paddle to sink heat away from the IC. Connect the battery to BATT as close as possible to the IC to provide accurate battery voltage sensing. Make all high-current traces short and wide to minimize voltage drops. A sample layout is available in the MAX8814 Evaluation Kit to speed designs.

Chip Information

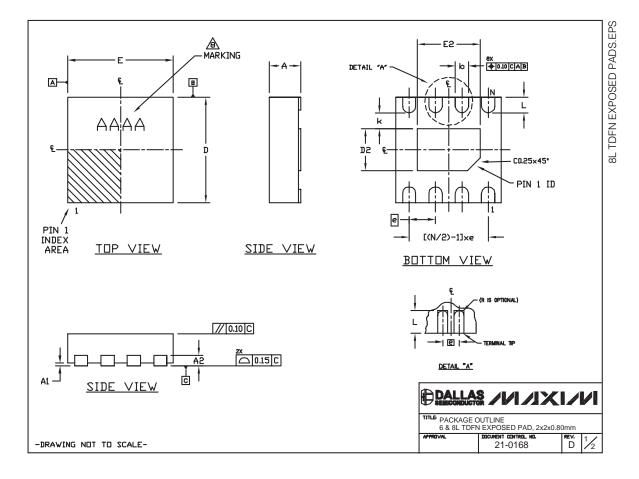
PROCESS: BICMOS

Pin Configuration



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)

COMMON DIMENSIONS					
SYMBOL	SYMBOL MIN. MAX.				
Α	0.70	0.80			
D	1.90 2.10				
E	1.90 2.10				
A1	0.00 0.05				
L	0.20 0.40				
k	0.25 MIN.				
A2	0.20 REF.				

PACKAGE VARIATIONS							
PKG. CODE	N	D2	E2	е	b	r	[(N/2)-1] x e
T622-1	6	0.90±0.10	1.60±0.10	0.65 TYP.	0.30±0.05	0.150	1.30 REF
T822-1	8	0.70±0.10	1.30±0.10	0.50 TYP.	0.25±0.05	0.125	1.50 REF
T822-2	8	0.80±0.10	1.20±0.10	0.50 TYP.	0.25±0.05	0.125	1.50 REF

NOTES:

- 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
- 2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. COPLANARITY SHALL NOT EXCEED 0.08 mm.
- 3. WARPAGE SHALL NOT EXCEED 0.08 mm.
- 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
- 5. COMPLY TO JEDEC MO229 EXCEPT D2 AND E2 DIMENSIONS.
- 6. "N" IS THE TOTAL NUMBER OF LEADS.
- 7. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- A MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.

-DRAWING NOT TO SCALE-

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